

**80V N-Channel Enhancement Mode MOSFET**

|                |              |                            |                 |
|----------------|--------------|----------------------------|-----------------|
| <b>Voltage</b> | <b>80 V</b>  | <b>R<sub>DS(ON)</sub></b>  | <b>3.4 mΩ</b>   |
| <b>Current</b> | <b>161 A</b> | <b>Q<sub>G</sub> (TYP)</b> | <b>103.5 nC</b> |

**Feature:**

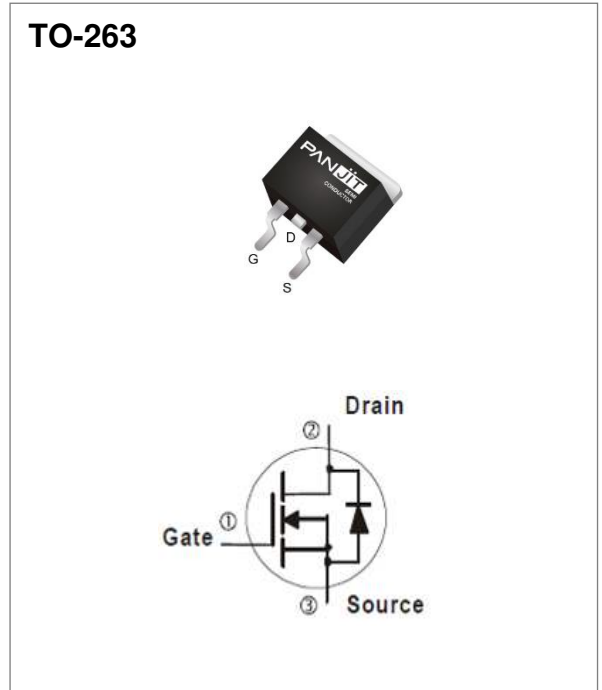
- R<sub>DS(ON)</sub> Max, V<sub>GS</sub>@10V, I<sub>D</sub>@50A<3.4mΩ
- R<sub>DS(ON)</sub> Max, V<sub>GS</sub>@7V, I<sub>D</sub>@25A<5mΩ
- 100% Avalanche Tested
- 100% Rg Tested
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

**Mechanical Data**

- Case: TO-263 package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 1.38 grams

**Application**

- BMS, BLDC, SMPS SR.



**Absolute Maximum Ratings** (T<sub>A</sub> = 25 °C unless otherwise specified)

| PARAMETER  | SYMBOL                            | LIMIT                         | UNITS |   |
|--|-----------------------------------|-------------------------------|-------|---|
| Drain-Source Voltage                             | V <sub>DS</sub>                   | 80                            | V     |   |
| Gate-Source Voltage                              | V <sub>GS</sub>                   | ±20                           |       |   |
| Continuous Drain Current                         | I <sub>D</sub>                    | T <sub>C</sub> =25°C (Note 3) | 161   | A |
|  |                                   | T <sub>C</sub> =100°C         | 102   |   |
| Pulsed Drain Current                             | I <sub>DM</sub>                   | 480                           | A     |   |
| Single Pulse Avalanche Current (Note 5)          | I <sub>AS</sub>                   | 38                            | A     |   |
| Single Pulse Avalanche Energy (Note 5)           | E <sub>AS</sub>                   | 722                           | mJ    |   |
| Power Dissipation                                | P <sub>D</sub>                    | T <sub>C</sub> =25°C          | 156   | W |
|  |                                   | T <sub>C</sub> =100°C         | 62.5  |   |
| Operating Junction and Storage Temperature Range | T <sub>J</sub> , T <sub>STG</sub> | -55~150                       | °C    |   |

**Thermal Characteristics**

| PARAMETER          | SYMBOL                       | MAXIMUM | UNITS |
|--------------------|------------------------------|---------|-------|
| Thermal Resistance | Junction-to-Case             | 0.8     | °C/W  |
|                    | Junction-to-Ambient (Note 4) | 62.5    | °C/W  |

**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise specified)

| PARAMETER                                    | SYMBOL              | TEST CONDITION  | MIN. | TYP.  | MAX.      | UNITS      |
|--|---------------------|---|------|-------|-----------|------------|
| <b>Static</b>                                |                     |   |      |       |           |            |
| Drain-Source Breakdown Voltage               | $BV_{DSS}$ (Note 7) | $V_{GS}=0V, I_D=250\mu A$                                       | 80   | -     | -         | V          |
| Gate Threshold Voltage                       | $V_{GS(th)}$        | $V_{DS}=V_{GS}, I_D=250\mu A$                                   | 2.25 | 3.2   | 3.75      |            |
| Drain-Source On-State Resistance<br>(Note 1) | $R_{DS(on)}$        | $V_{GS}=10V, I_D=50A$   | -    | 3     | 3.4       | m $\Omega$ |
|  |                     | $V_{GS}=7V, I_D=25A$  | -    | 3.5   | 5         |            |
| Zero Gate Voltage Drain Current              | $I_{DSS}$           | $V_{DS}=80V, V_{GS}=0V$   | -    | -     | 1         | $\mu A$    |
| Gate-Source Leakage Current                  | $I_{GSS}$           | $V_{GS}=\pm 20V, V_{DS}=0V$                                     | -    | -     | $\pm 100$ | nA         |
| <b>Dynamic</b> (Note 6)                      |                     |   |      |       |           |            |
| Total Gate Charge                            | $Q_g$               | $V_{DS}=40V, I_D=50A,$<br>$V_{GS}=7V$                           | -    | 76    | -         | nC         |
|  |                     | $V_{DS}=40V, I_D=50A,$<br>$V_{GS}=10V$                          | -    | 103.5 | -         |            |
| Gate-Source Charge                           | $Q_{gs}$            |   | -    | 34.1  | -         |            |
| Gate-Drain Charge                            | $Q_{gd}$            | -   | 20.9 | -     |           |            |
| Input Capacitance                            | $C_{iss}$           | $V_{DS}=40V, V_{GS}=0V,$<br>$F=1MHz$                            | -    | 7430  | -         | pF         |
| Output Capacitance                           | $C_{oss}$           |   | -    | 1483  | -         |            |
| Reverse Transfer Capacitance                 | $C_{rss}$           |   | -    | 89    | -         |            |
| Turn-On Delay Time                           | $t_{d(on)}$         | $V_{DD}=40V, I_D=50A,$<br>$V_{GS}=10V, R_G=2\Omega$<br>(Note 2) | -    | 70.6  | -         | ns         |
| Turn-On Rise Time                            | $t_r$               |   | -    | 103   | -         |            |
| Turn-Off Delay Time                          | $t_{d(off)}$        |   | -    | 122   | -         |            |
| Turn-Off Fall Time                           | $t_f$               |   | -    | 48.5  | -         |            |
| Gate Resistance                              | $R_g$               | $f=1.0MHz$  | -    | 3.2   | -         | $\Omega$   |
| <b>Drain-Source Diode</b>                    |                     |   |      |       |           |            |
| Diode Forward Voltage                        | $V_{SD}$            | $I_S=50A, V_{GS}=0V$  | -    | 0.88  | 1.2       | V          |
| Reverse Recovery Charge                      | $Q_{rr}$            | $I_S=50A$   | -    | 114   | -         | nC         |
| Reverse Recovery Time                        | $T_{rr}$            | $di/dt=100A/\mu s$  | -    | 69    | -         | ns         |

NOTES :

1. Pulse width < 580 $\mu s$ ,
2. Essentially independent of operating temperature typical characteristics.
3. The maximum current rating is silicon limited.
4.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz. square pad of copper.
5. The test condition is  $L=1mH, I_{AS}=38A, V_{DD}=40V, V_{GS}=10V, R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
6. Guaranteed by design, not subject to production testing.
7.  $BV_{DSS}$  is over 85V during mass production.

TYPICAL CHARACTERISTIC CURVES

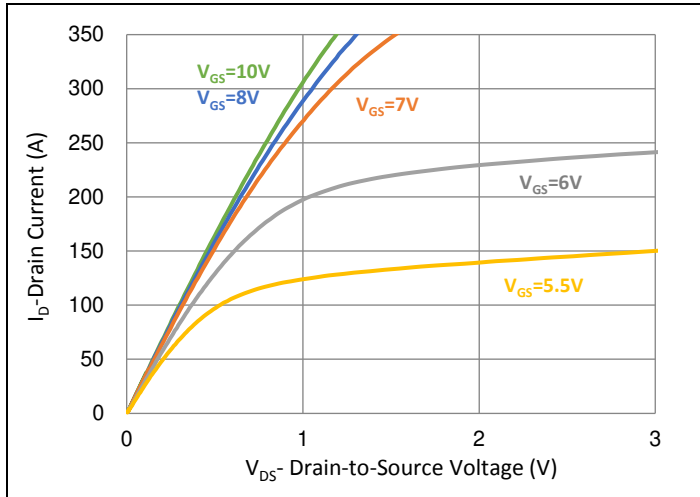


Fig.1 Output Characteristics

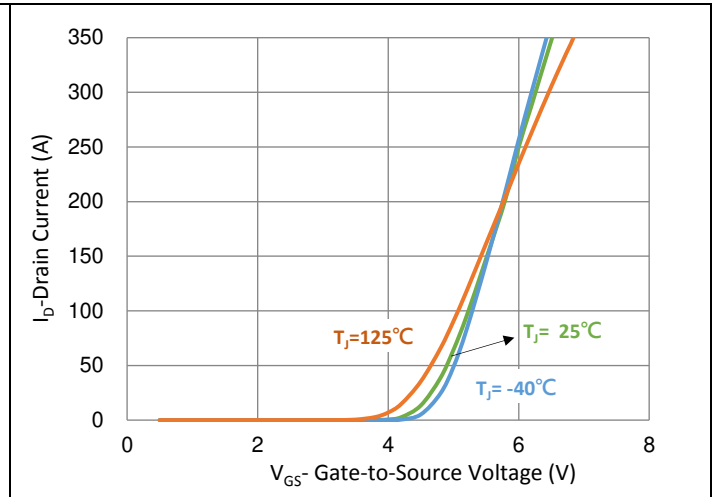


Fig.2 Transfer Characteristics

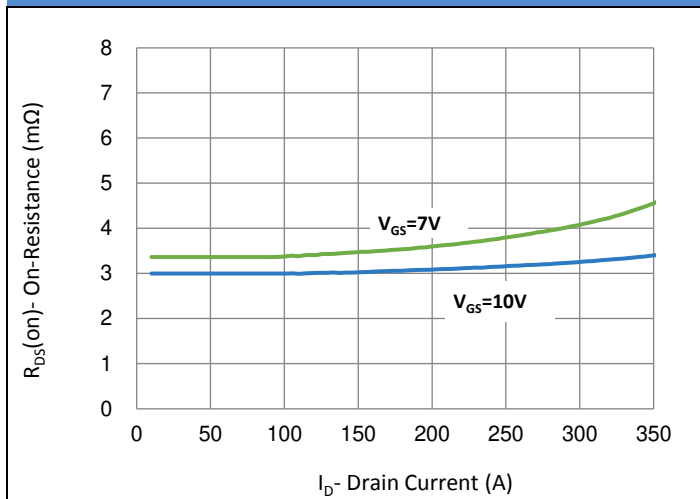


Fig.3 On-Resistance vs. Drain Current

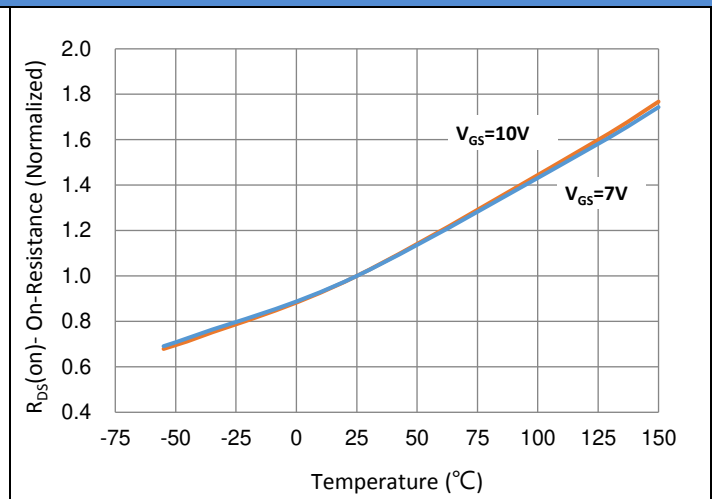


Fig.4 On-Resistance vs. Junction Temperature

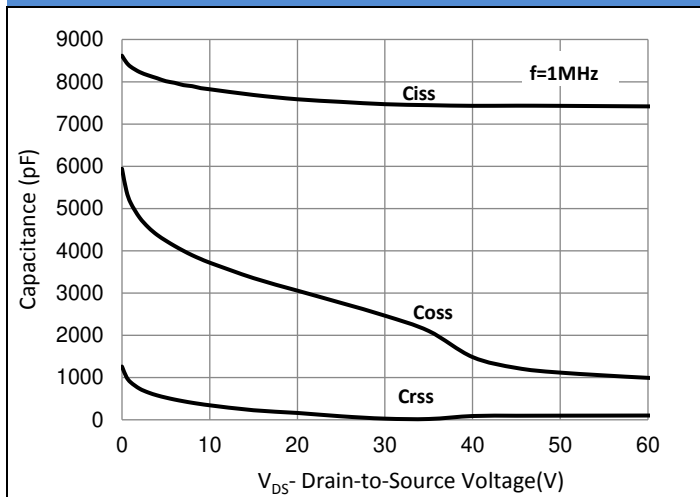


Fig.5 Capacitance vs. Drain-Source Voltage

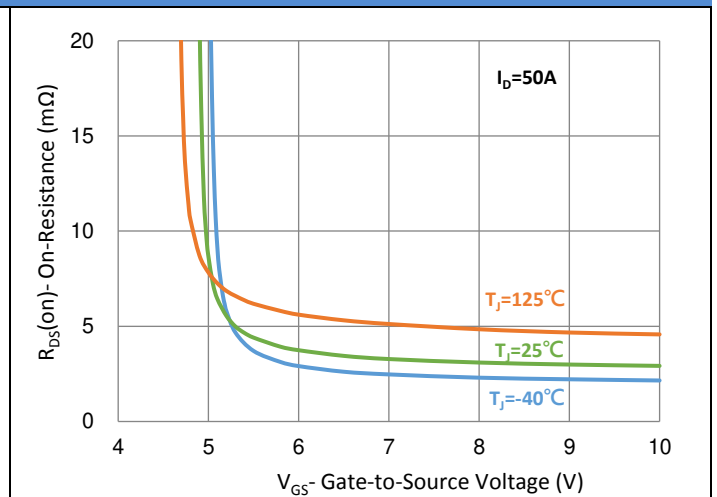


Fig.6 On-Resistance vs. Gate-Source Voltage

TYPICAL CHARACTERISTIC CURVES

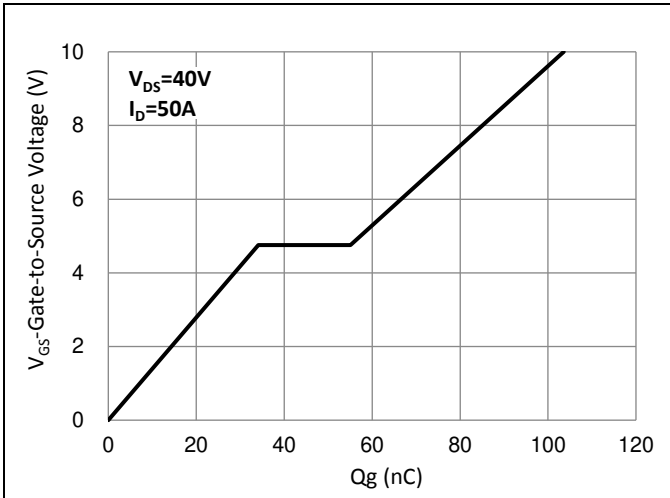


Fig.7 Gate-Charge Characteristics

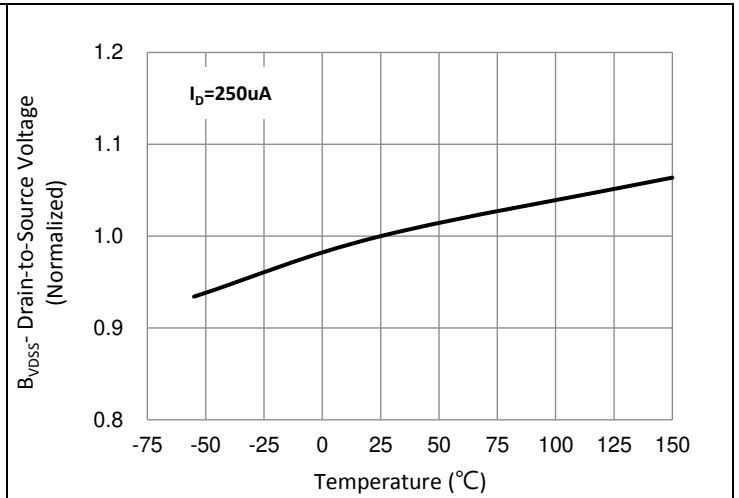


Fig.8 Breakdown Voltage Variation vs. Temperature

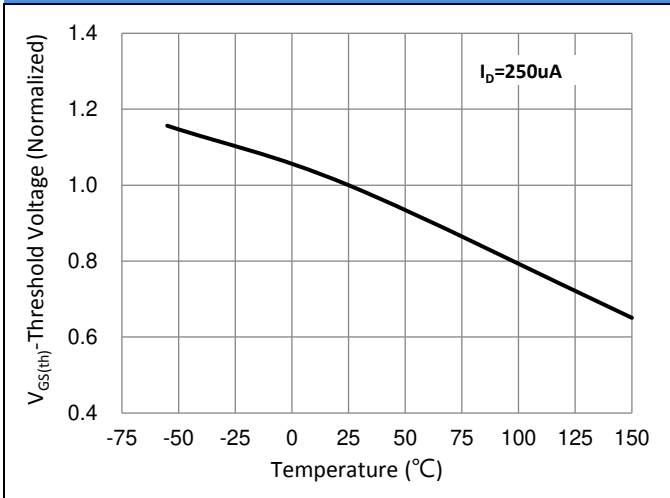


Fig.9 Threshold Voltage Variation with Temperature

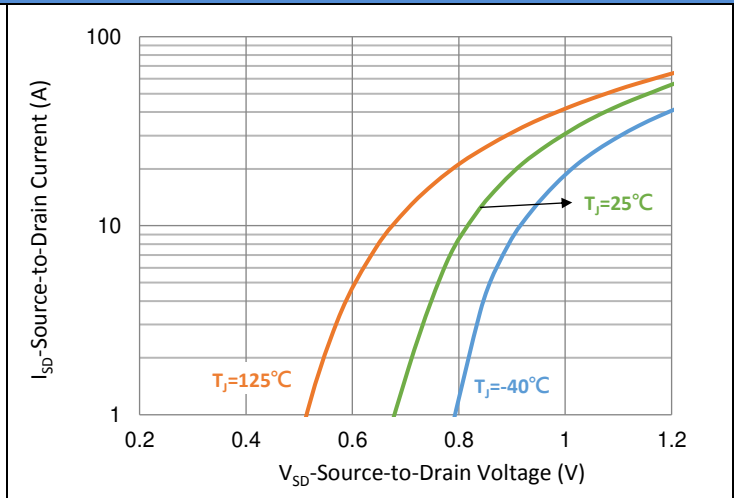


Fig.10 Source-Drain Diode Forward Voltage

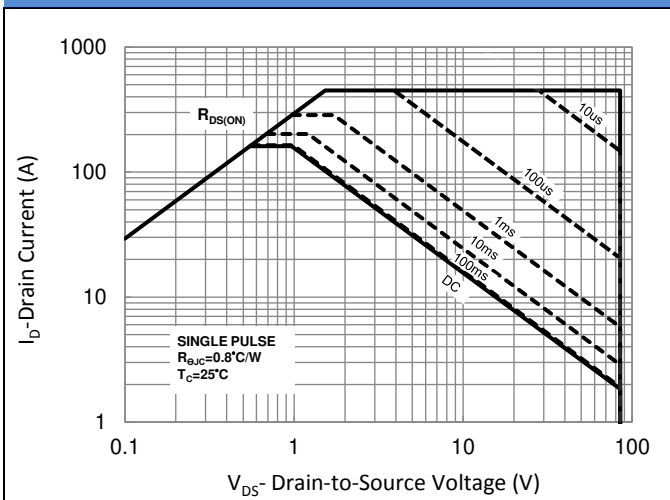


Fig.11 Maximum Safe Operating Area

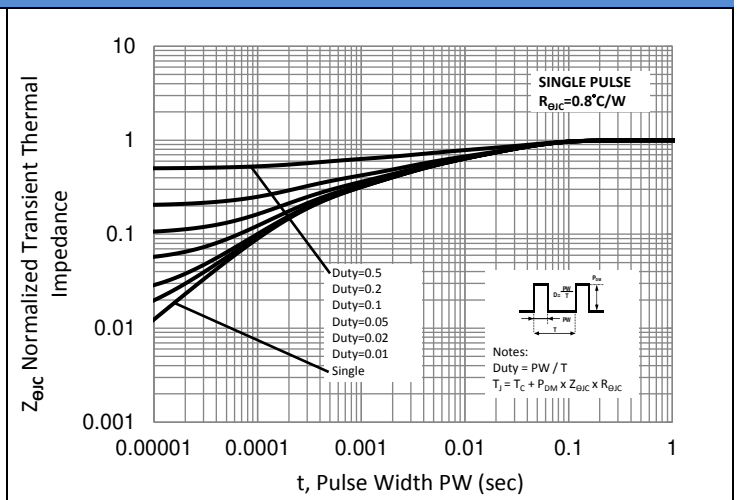


Fig.12 Normalized Transient Thermal Impedance

TYPICAL CHARACTERISTIC CURVES

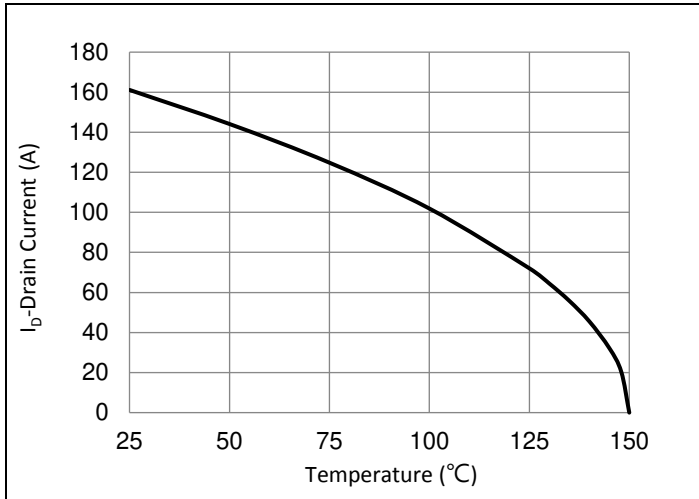


Fig.13 Drain Current vs. Case Temperature



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